Proposed Institute Elective course

Name: Introduction to MicroElectroMechanical Systems (MEMS)

COURSE OUTLINE: Introduction to MEMS, Scaling Effects, Microfabrication fundamentals, Mechanics and transduction at the microscale, Actuation and sensing methods – Electrostatic, Piezoresistive, Piezoelectric, Thermal, Electromagnetic, Resonant and tunneling. Capacitative sensors, Resonators, Lab on Chip devices, Microfluidics. Assembly techniques for MEMS and packaging.

OBJECTIVE: To provide an overview of different applications of MEMS in sensing and actuation and provide a basic understanding of construction and mechanics underlying these systems.

COURSE CONTENTS:

Introduction:

MEMS definition, applications, markets, technology development, history, rationale, scaling of forces and dimension

Microfabrication:

Bulk micromachining, surface micromachining, Non-conventional micromachining – microelectrodischarge machining, ultrasonic machining, laser micromachining, nano imprinting, focused ion beam machining, screen printing, soft lithography, injection molding, hot embossing, stereolithography.

Actuation and Sensing:

Mechanics at microscale – microstructural elements, Stiction and control. Actuation principles – Electrostatic, Piezoresistive, Piezoelectric, Thermal, Electromagnetic, Resonant and tunneling.

MEMS Applications:

Case studies of accelerometer, pressure sensor, microphones, ink-jet print heads, resonators, digital micromirrors and microfluidic devices.

Microfluidics:

Fluid dynamics at the microscale, electrokinetics, surface tension driven transport, microfluidics for DNA analysis, Lab-on-Chip applications, Micropumps, microvalves, mixers. Process

Integration:

Wafer bonding and packaging, Assembly techniques for MEMS.

Reference Books:

MEMS:

• N. Maluf, *An introduction to microelectromechanical systems engineering*, Artech House 2000 Chang Liu, Foundations of MEMS (2nd edition), 2012

• W. Trimmer, Micromechanics and MEMS: Classic and seminal papers to 1990, IEEE

• G.T.A. Kovacs, Micromachined Transducers Sourcebook, McGraw-Hill, 1998

• M. Gad-el-Hak, The MEMS Handbook, CRC Press, 2002

Microfluidics:

• G. Karniadakis, A. Beskok, N. Aluru *Microflows and Nanoflows: Fundamentals and Simulation*, Springer 2005.

• Geshke, Microsystem Engineering of Lab-on-a-chip Devices, John Wiley Sons, 2004

• P. Tabeling, Introduction to microfluidics, Oxford University Press, 2005.

• J Kutter, Y. Fintshenko, Separation methods in microanalytical systems, Taylor & Francis 2006

• N. T. Nguyen, S. Wereley Fundamentals and Applications of Microfluidics,

Artech House Publishers, 2002

Design:

• Stephen D. Senturia, *Microsystem Design*, Kluwer Academic Publishers, 2000 **Microfabrication**:

• S. A. Campbell, *Science and Engineering of Microelectronic Fabrication*, Oxford University Press, 2005.

- M. Madou, Fundamentals of Microfabrication, New York: CRC Press, 1997
- M. Elwenspoek, H. Jansen, Silicon Micromachining, Kluwer Academic Publishers, 2001
- P. Van Zant, *Microchip fabrication: a practical guide*, McGraw Hill 2004 (TK 7871.85 V36)

• D.V. Morga, K. Board, An introduction to semiconductor technology, Wiley 1990 (TK 7871.85.M585)

• P. Gise, R. Blanchard, *Modern semiconductor fabrication technology*, Prentice Hall 1986. (TK 7871.85 G48)